

## 2A Synchronous-Buck LED Drivers with Integrated MOSFETs

## MAX20050–MAX20053

### General Description

The MAX20050–MAX20053 are high-brightness LED (HB LED) drivers for automotive exterior lighting applications. Consisting of a fully synchronous step-down converter with integrated MOSFETs, the devices are capable of driving a series string of LEDs at up to 2A, with a minimum number of external components. The MAX20050/MAX20052 utilize internal loop compensation to minimize component count, while the MAX20051/MAX20053/MAX20053D use external compensation for full flexibility.

The wide 4.5V to 65V input supply range supports extreme automotive cold crank and load-dump conditions. A low- and high-switching frequency option (400kHz or 2.1MHz) provides the designer with the flexibility to optimize for solution size or efficiency, while avoiding interference within the AM band. Spread spectrum provides further options for the designer to reduce EMI at the system level. The MAX20050/MAX20051 have an internal switching frequency of 400kHz, while the MAX20052/MAX20053/MAX20053D have an internal switching frequency of 2.1MHz. In addition, the MAX20051B has spread spectrum disabled.

High-side current regulation means only a single connection to the LED string is required; grounding of the string can be done locally. In addition to PWM dimming, the ICs provide analog dimming using the REFI pin. Full-scale current regulation accuracy is  $\pm 2.5\%$ , while the accuracy is  $\pm 8\%$  at 10% of full-scale over the full temperature range of  $-40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$ . A 5V, 10mA LDO output is available for biasing other circuits.

Fault-protection mechanisms include output overload, short-circuit, and device overtemperature protection. The devices are specified for operation over the full  $-40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$  temperature range and are available in thermally enhanced 12-pin (3mm x 3mm) TDFN, 14-pin (5mm x 4.4mm) TSSOP, and 24-pin TQFN (4mm x 4mm) packages with an exposed pad.

### Applications

- Daytime Running Lamps (DRLs)
- Fog Lamps
- Clearance Lamps (CLLs)
- Corner Lamps (CLs)
- Rear Lamps
- Head Lamps
- Commercial, Industrial, and Architectural Lighting
- Driver Monitoring Systems (DMS)

### Benefits and Features

- Automotive Ready: AEC-Q100 Qualified
- Fully Synchronous 2A Step-Down Converter with Integrated  $0.14\Omega$  (typ) MOSFETs
- Wide 4.5V to 65V Input Supply Range
- Two Switching Frequency Options: 400kHz and 2.1MHz
- Internal Loop Compensation (MAX20050/MAX20052) and External Loop Compensation (MAX20051/MAX20053/MAX20053D) Options
- Switching Frequency Synchronized to PWM Dimming Signal
- Active-Low Fault (FLT) Indicator
- Output Short-Circuit Protection
- High-Side Current Regulation Eliminates One Connection to LED String
- Spread-Spectrum Mode Alleviates EMI Problems
- Low 200mV Full-Scale High-Side Current-Sense Voltage
- REFI Pin Adjusts LED Current Down to Zero
- PWM Dimming Disconnects Both High- and Low-Side MOSFET Drivers
- 5V, 10mA LDO Output Provides Bias to Other Circuits
- Ultra-Low Shutdown Current ( $5\mu\text{A}$ , typ)
- Output Overload, Short-Circuit, and Overtemperature Protections
- 12-Pin (3mm x 3mm) TDFN, 14-Pin (5mm x 4.4mm) TSSOP, and 24-pin (4mm x 4mm) TQFN Package Options

[Ordering Information](#) appears at end of data sheet.

### Absolute Maximum Ratings

|                                              |                                      |
|----------------------------------------------|--------------------------------------|
| IN to AGND                                   | .....-0.3V to +70V                   |
| IN to AGND (MAX20050C/51C/52C/53C/53D only)  | .....-0.3V to 40V                    |
| PGND to AGND                                 | .....-0.3V to +0.3V                  |
| CS+, CS-, LX to AGND                         | .....-0.3V to (IN + 0.3V)            |
| BST to AGND                                  | .....-0.3V to +75V                   |
| BST to AGND (MAX20050C/51C/52C/53C/53D only) | ... -0.3V to 45V                     |
| BST to LX                                    | .....-0.3V to +6V                    |
| PWM, FLT to AGND                             | .....-0.3V to +6V                    |
| V <sub>CC</sub> to AGND                      | .....-0.3V to MIN (+6V, IN + 0.3V)   |
| COMP, REFI to AGND                           | .....-0.3V to V <sub>CC</sub> + 0.3V |
| CS+ to CS-                                   | .....-0.3V to + 0.3V                 |
| Continuous Current on LX                     | .....2.1A                            |
| Continuous Current on IN for TDFN            | .....1.6A                            |

|                                                                |                      |
|----------------------------------------------------------------|----------------------|
| Continuous Current on IN for TQFN                              | .....1.8A            |
| Continuous Current on IN for TSSOP                             | .....2.1A            |
| Short-Circuit Duration on V <sub>CC</sub>                      | .....Continuous      |
| Continuous Power Dissipation (T <sub>A</sub> = +70°C) (Note 1) |                      |
| 12-Pin TDFN-EP (derate 24.4 mW/°C above +70°C)                 | .....1951.2mW        |
| 14-Pin TSSOP-EP (derate 25.6 mW/°C above +70°C)                | .....2051.3mW        |
| Operating Temperature Range                                    | .....-40°C to +125°C |
| Junction Temperature                                           | .....+150°C          |
| Storage Temperature Range                                      | .....-65°C to +150°C |
| Lead Temperature (soldering, 10s)                              | .....+300°C          |
| Soldering Temperature (reflow)                                 | .....+260°C          |

### Package Thermal Characteristics (Note 1)

#### TDFN

|                                                           |              |
|-----------------------------------------------------------|--------------|
| Junction-to-Ambient Thermal Resistance (θ <sub>JA</sub> ) | .....41°C/W  |
| Junction-to-Case Thermal Resistance (θ <sub>JC</sub> )    | .....8.5°C/W |

#### TSSOP

|                                                           |             |
|-----------------------------------------------------------|-------------|
| Junction-to-Ambient Thermal Resistance (θ <sub>JA</sub> ) | .....39°C/W |
| Junction-to-Case Thermal Resistance (θ <sub>JC</sub> )    | .....3°C/W  |

#### TQFN

|                                                           |             |
|-----------------------------------------------------------|-------------|
| Junction-to-Ambient Thermal Resistance (θ <sub>JA</sub> ) | .....36°C/W |
| Junction-to-Case Thermal Resistance (θ <sub>JC</sub> )    | .....3°C/W  |

Note 1: Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to [www.maximintegrated.com/thermal-tutorial](http://www.maximintegrated.com/thermal-tutorial).

### Electrical Characteristics

(V<sub>IN</sub> = 12V, V<sub>REFI</sub> = 1.2V, V<sub>PWM</sub> = V<sub>CC</sub>, T<sub>A</sub> = T<sub>J</sub> = -40°C to +125°C, unless otherwise noted. Typical values are at T<sub>A</sub> = +25°C.) (Note 2)

| PARAMETER                                    | SYMBOL              | CONDITIONS                                                                               |                                                        | MIN | TYP   | MAX  | UNITS |   |
|----------------------------------------------|---------------------|------------------------------------------------------------------------------------------|--------------------------------------------------------|-----|-------|------|-------|---|
| Input Supply Voltage                         | V <sub>IN</sub>     |                                                                                          |                                                        | 4.5 |       | 65   | V     |   |
|                                              |                     | MAX20050C/51C/52C/53C/53D only (Note 5)                                                  |                                                        | 4.5 |       | 36   |       |   |
| IN Undervoltage Lockout                      | V <sub>INUVLO</sub> | V <sub>IN</sub> rising inferred by V <sub>CCUVLOR</sub>                                  |                                                        |     |       | 4.45 | V     |   |
| IN Undervoltage Hysteresis                   | V <sub>INHSTL</sub> |                                                                                          |                                                        |     | 225   |      | mV    |   |
| Supply Current                               | I <sub>INQ</sub>    | PWM = 0<br>(no switching)                                                                | V <sub>IN</sub> = 12V                                  |     | 5     | 8    | μA    |   |
|                                              |                     |                                                                                          | V <sub>IN</sub> = 65V                                  |     | 8     | 20   |       |   |
|                                              |                     | PWM = 100%<br>(and during regulation<br>switching)                                       | V <sub>IN</sub> = 12V<br>(MAX20050/51/<br>50C/51C)     |     | 5     | 10   | mA    |   |
|                                              |                     |                                                                                          | V <sub>IN</sub> = 12V<br>(MAX20052/53/<br>52C/53C/53D) |     | 20    |      |       |   |
|                                              |                     |                                                                                          | V <sub>IN</sub> = 65V<br>(MAX20050/51)                 |     | 10    |      |       |   |
|                                              |                     |                                                                                          |                                                        |     |       |      |       |   |
| V <sub>CC</sub> REGULATOR (V <sub>CC</sub> ) |                     |                                                                                          |                                                        |     |       |      |       |   |
| V <sub>CC</sub> Output Voltage               | V <sub>CC</sub>     | I <sub>VCC</sub> = 1mA, 5.5V < V <sub>IN</sub> < 65V                                     |                                                        |     | 4.875 | 5    | 5.125 | V |
|                                              |                     | I <sub>VCC</sub> = 1mA, 5.5V < V <sub>IN</sub> < 36V<br>(MAX20050C/51C/52C/53C/53D only) |                                                        |     |       |      |       |   |
|                                              |                     | I <sub>VCC</sub> = 10mA, 6V < V <sub>IN</sub> < 25V                                      |                                                        |     |       |      |       |   |

## Electrical Characteristics (continued)

(V<sub>IN</sub> = 12V, V<sub>REFI</sub> = 1.2V, V<sub>PWM</sub> = V<sub>CC</sub>, T<sub>A</sub> = T<sub>J</sub> = -40°C to +125°C, unless otherwise noted. Typical values are at T<sub>A</sub> = +25°C.) (Note 2)

| PARAMETER                             | SYMBOL                 | CONDITIONS                                                           |                                             | MIN   | TYP  | MAX   | UNITS |
|---------------------------------------|------------------------|----------------------------------------------------------------------|---------------------------------------------|-------|------|-------|-------|
| V <sub>CC</sub> Dropout Voltage       |                        | I <sub>VCC</sub> = 5mA, V <sub>IN</sub> = 4.5V                       |                                             |       | 50   | 100   | mV    |
| V <sub>CC</sub> Short-Circuit Current | V <sub>CC</sub> IMAX   | V <sub>CC</sub> = 0V                                                 |                                             | 50    | 80   | 110   | mA    |
|                                       |                        | V <sub>CC</sub> = 0V, MAX20053D                                      |                                             | 40    | 80   | 110   |       |
| V <sub>CC</sub> Undervoltage Lockout  | V <sub>CC</sub> UVLOR  | Rising                                                               |                                             | 4     | 4.2  | 4.35  | V     |
|                                       | V <sub>CC</sub> UVLHYS | Hysteresis                                                           |                                             | 150   | 200  | 250   | mV    |
| REFI Input Voltage Range              | REFI <sub>RNG</sub>    |                                                                      |                                             | 0.2   |      | 1.20  | V     |
| REFI Zero-Current Threshold           | REFI <sub>ZC_VTH</sub> | CS <sub>DIFF</sub> < 5mV                                             |                                             | 0.165 | 0.18 | 0.195 | V     |
| REFI Clamp Voltage                    | REFI <sub>CLMP</sub>   | I <sub>REFI</sub> sink = 1μA                                         |                                             | 1.274 | 1.3  | 1.326 | V     |
| Input Bias Current                    | REFI <sub>IIN</sub>    | V <sub>REFI</sub> = 0 to V <sub>CC</sub>                             |                                             | 0     | 20   | 200   | nA    |
|                                       |                        | V <sub>REFI</sub> = 0 to V <sub>CC</sub> (MAX200051B only)           |                                             | 0     | 20   | 300   |       |
| Common-Mode Input Range               | CSCM <sub>IIN</sub>    |                                                                      |                                             | -0.2  |      | +65   | V     |
| Differential Signal Range             | CS <sub>DIFF</sub>     |                                                                      |                                             | 0     |      | 200   | mV    |
| CS+ Input Bias Current                | IB <sub>CS+</sub>      | V <sub>CS+</sub> = 60V                                               | V <sub>CS+</sub> - V <sub>CS-</sub> = 200mV |       | 40   | 70    | μA    |
|                                       |                        |                                                                      | V <sub>CS+</sub> - V <sub>CS-</sub> = 0V    |       | 8    | 15    |       |
| CS- Input Bias Current                | IB <sub>CS-</sub>      | V <sub>CS-</sub> = 60V                                               | V <sub>CS+</sub> - V <sub>CS-</sub> = 200mV |       | 100  | 150   | μA    |
|                                       |                        |                                                                      | V <sub>CS+</sub> - V <sub>CS-</sub> = 0V    |       | 66   | 110   |       |
| Current-Sense Input Offset            | CS <sub>OS</sub>       | T <sub>J</sub> = 25°C, CSCM <sub>IIN</sub> 3V to 60V                 |                                             |       | -0.1 |       | mV    |
|                                       |                        | 3V < CSCM <sub>IIN</sub> < 60V                                       |                                             | -1.8  |      | +1.8  |       |
|                                       |                        | 3V < CSCM <sub>IIN</sub> < 60V, MAX20053D                            |                                             |       | -0.1 |       |       |
| Current-Sense Voltage Gain            | CS <sub>GAIN</sub>     | (CS+ - CS-) = 200mV,<br>3V < CSCM <sub>IIN</sub> < 60V               |                                             | 4.95  | 5    | 5.05  | V/V   |
|                                       |                        |                                                                      | B,C,D versions                              | 4.91  | 5    | 5.08  |       |
| Regulation Voltage Accuracy           | CS <sub>ACC</sub>      | REFI = 1.4V, 3V < CSCM <sub>IIN</sub> < 60V                          |                                             | 215   | 220  | 225   | mV    |
|                                       |                        | REFI = 1.2V, 3V < CSCM <sub>IIN</sub> < 60V                          |                                             | 196   | 200  | 204   |       |
|                                       |                        | REFI = 1.2V, 3V < CSCM <sub>IIN</sub> < 60V,<br>MAX20053D            |                                             | 196   | 200  | 205   |       |
|                                       |                        | REFI = 0.7V, 3V < CSCM <sub>IIN</sub> < 60V                          |                                             |       | 100  |       |       |
|                                       |                        | REFI = 0.4V, 3V < CSCM <sub>IIN</sub> < 60V                          |                                             | 37.8  | 40   | 42.2  |       |
|                                       |                        | REFI = 0.4V, 3V < CSCM <sub>IIN</sub> < 60V,<br>MAX20053D            |                                             | 37.8  | 40   | 43.1  |       |
| Regulation Voltage Accuracy Low Range | CS <sub>ACC</sub>      | V <sub>REFI</sub> = 1.2V 0V < CSCM <sub>IIN</sub> < 3V               |                                             | 192   | 200  | 208   | mV    |
|                                       |                        | V <sub>REFI</sub> = 0.4V 0V < CSCM <sub>IIN</sub> < 3V               |                                             | 35    | 40   | 45    |       |
|                                       |                        | V <sub>REFI</sub> = 1.2V 0V < CSCM <sub>IIN</sub> < 3V,<br>MAX20053D |                                             | 192   | 200  | 209.1 |       |
|                                       |                        | V <sub>REFI</sub> = 0.4V 0V < CSCM <sub>IIN</sub> < 3V,<br>MAX20053D |                                             | 35    | 40   | 46.5  |       |

## Electrical Characteristics (continued)

(V<sub>IN</sub> = 12V, V<sub>REFI</sub> = 1.2V, V<sub>PWM</sub> = V<sub>CC</sub>, T<sub>A</sub> = T<sub>J</sub> = -40°C to +125°C, unless otherwise noted. Typical values are at T<sub>A</sub> = +25°C.) (Note 2)

| PARAMETER                           | SYMBOL                | CONDITIONS                                            | MIN                   | TYP               | MAX                   | UNITS |
|-------------------------------------|-----------------------|-------------------------------------------------------|-----------------------|-------------------|-----------------------|-------|
| CS Common-Mode Range Input Selector | RNG <sub>SEL</sub>    | V <sub>CS+</sub> rising                               | 2.7                   | 2.85              | 3.0                   | V     |
|                                     |                       | V <sub>CS+</sub> falling                              | 2.45                  | 2.6               | 2.75                  |       |
| Cycle-by-Cycle Current Limit        | CS <sub>LIM</sub>     | V <sub>CS-</sub> > OUT <sub>VTH_LOW</sub>             | 285                   | 300               | 315                   | mV    |
|                                     |                       | V <sub>CS-</sub> > OUT <sub>VTH_LOW</sub> , MAX20053D | 282                   | 300               | 315                   |       |
|                                     |                       | V <sub>CS-</sub> < OUT <sub>VTH_LOW</sub>             | CS <sub>ACC</sub> - 5 | CS <sub>ACC</sub> | CS <sub>ACC</sub> + 5 |       |
| Transconductance                    | g <sub>M</sub>        | V <sub>CS+</sub> - V <sub>CS-</sub> = 200mV           | 480                   | 600               | 720                   | μS    |
| Open-Loop DC Gain                   |                       |                                                       |                       | 75                |                       | dB    |
| COMP Bias Current                   | COMP <sub>IBIAS</sub> | PWM = 0                                               | -200                  |                   | +200                  | nA    |
| COMP Sink Current                   | COMP <sub>ISINK</sub> | V <sub>COMP</sub> = 5V                                | 85                    | 100               | 115                   | μA    |
|                                     |                       | V <sub>COMP</sub> = 5V, MAX20053D                     | 80                    | 100               | 115                   |       |
| COMP Source Current                 | COMP <sub>ISRC</sub>  | V <sub>COMP</sub> = 0V                                | 85                    | 100               | 115                   | μA    |
|                                     |                       | V <sub>COMP</sub> = 0V, MAX20053D                     | 80                    | 100               | 115                   |       |
| High-Side DMOS R <sub>DS(ON)</sub>  | R <sub>ON,HS</sub>    | I <sub>LX</sub> = 200mA, V <sub>CS+</sub> = 3V        |                       | 170               | 340                   | mΩ    |
| Low-Side DMOS R <sub>DS(ON)</sub>   | R <sub>ON,LS</sub>    | V <sub>CC</sub> = 5V, I <sub>LX</sub> = 200mA         |                       | 140               | 300                   | mΩ    |
| LX Rise Time                        | t <sub>RISE,LS</sub>  |                                                       |                       | 10                |                       | ns    |
| Switching Frequency                 | f <sub>SW</sub>       | MAX20050/MAX20051, frequency dither disabled          | 360                   | 400               | 440                   | kHz   |
|                                     |                       | MAX20052/MAX20053, frequency dither disabled          | 1890                  | 2100              | 2310                  |       |
| Minimum On-Time                     | t <sub>ON_MIN</sub>   |                                                       | 50                    | 80                | 120                   | ns    |
| Minimum Off-Time                    | t <sub>OFF_MIN</sub>  |                                                       | 50                    | 80                | 120                   | ns    |
|                                     |                       | MAX20053D                                             | 40                    | 60                | 90                    |       |
| Spread-Spectrum Range               | SS                    | Not applicable to B version                           |                       | ±3                |                       | %     |
| PWM Input Frequency                 | PWM <sub>FR</sub>     |                                                       | 10                    |                   | 2000                  | Hz    |
| PWM-to-LX Delay                     | PWM <sub>DLY</sub>    | Rising (during regulation)                            |                       | 2                 | 5                     | μs    |
|                                     |                       | Falling (during regulation)                           |                       | 2                 | 5                     |       |
| PWM Threshold                       | PWM <sub>VTHR</sub>   | Rising                                                |                       |                   | 2                     | V     |
|                                     | PWM <sub>VTHF</sub>   | Falling                                               | 800                   |                   |                       | mV    |
| PWM Pullup Current                  | PWM <sub>RIN</sub>    | V <sub>IN</sub> = 12V                                 | 1                     | 2                 | 3                     | μA    |
| PWM Shutdown Timer                  | PWM <sub>SHDW</sub>   | PWM low time to enter shutdown mode                   | 140                   | 210               | 300                   | ms    |
| Startup Time                        | t <sub>STUP</sub>     | IN, PWM rising to LX delay                            | 180                   | 250               | 350                   | μs    |
| Thermal Shutdown                    |                       | Rising                                                |                       | 165               |                       | °C    |
|                                     |                       | Hysteresis                                            |                       | 10                |                       | °C    |

## Electrical Characteristics (continued)

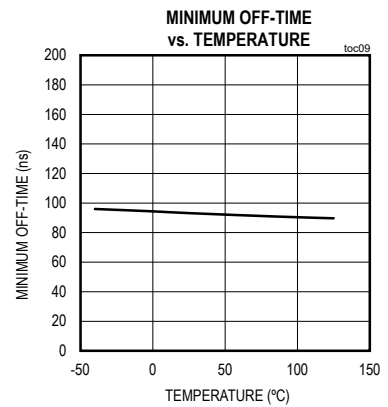
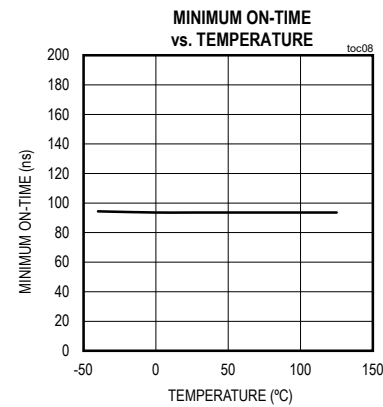
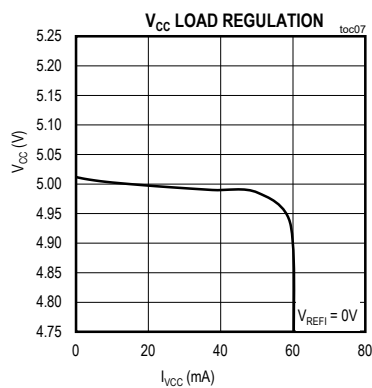
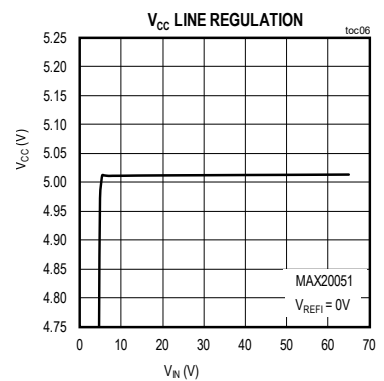
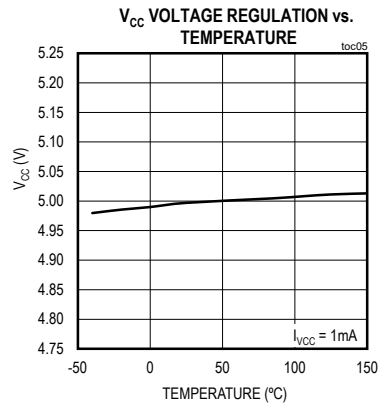
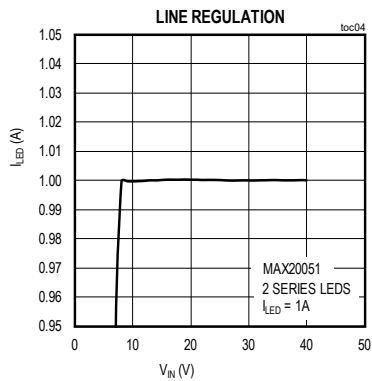
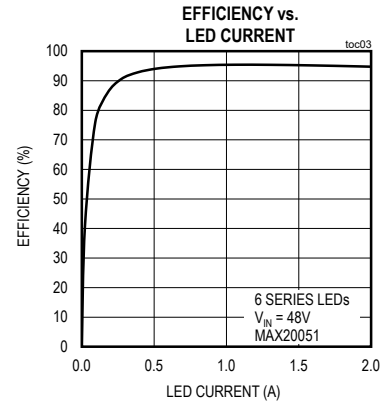
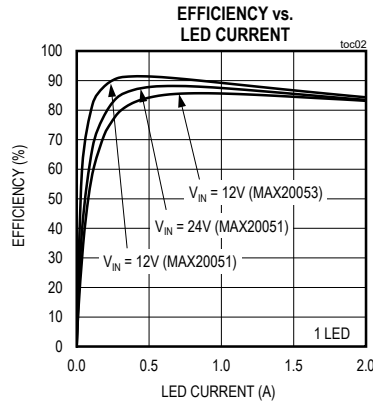
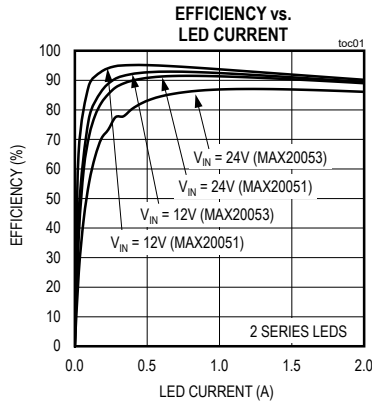
(V<sub>IN</sub> = 12V, V<sub>REFI</sub> = 1.2V, V<sub>PWM</sub> = V<sub>CC</sub>, T<sub>A</sub> = T<sub>J</sub> = -40°C to +125°C, unless otherwise noted. Typical values are at T<sub>A</sub> = +25°C.) (Note 2)

| PARAMETER                               | SYMBOL                  | CONDITIONS                                                                         | MIN  | TYP  | MAX  | UNITS |
|-----------------------------------------|-------------------------|------------------------------------------------------------------------------------|------|------|------|-------|
| LED Open-Fault REFI Range               | LOF <sub>REFI_RNG</sub> | V <sub>REFI</sub> rising                                                           | 300  | 325  | 350  | mV    |
| LED Open-Fault Enable Rising Threshold  | LOF <sub>IN_RNG</sub>   | V <sub>IN</sub> rising                                                             | 8    | 9    | 10   | V     |
| LED Open-Fault Enable Falling Threshold | LOF <sub>IN_FLNG</sub>  | V <sub>IN</sub> falling                                                            | 7.3  | 8.3  | 9.3  | V     |
| LED Open-Fault Threshold                | LOF <sub>VTH</sub>      | CS <sub>DIFF</sub> falling, duty = max                                             | 10   | 25   | 40   | %     |
| LED Open-Fault Hysteresis               | LOF <sub>VTH_HYS</sub>  |                                                                                    | 3    | 6    | 9    | %     |
| Output-Voltage Low Threshold            | OUTV <sub>TH_LOW</sub>  | V <sub>CS-</sub> falling                                                           | 1.35 | 1.5  | 1.65 | V     |
| FAULT Output Voltage                    | FAULT <sub>VOL</sub>    | I <sub>SINK</sub> = 1mA, V <sub>CS+</sub> = 1V, after FAULT <sub>DEG</sub> elapsed |      | 0.05 | 0.3  | V     |
| FAULT Deglitch Timer                    | FAULT <sub>DEG</sub>    | (Note 3)                                                                           | 70   | 105  | 150  | μs    |
| FAULT Mask Timer                        | FAULT <sub>MASK</sub>   | (Note 4)                                                                           | 140  | 210  | 300  | μs    |
| FAULT Leakage Current                   | FAULT <sub>LCK</sub>    | V <sub>FAULT</sub> = 5.5V                                                          |      |      | 1    | μA    |

**Note 2:** 100% tested at T<sub>A</sub> = +25°C. All limits over temperature are guaranteed by design, not production tested.**Note 3:** The time duration for which the fault condition has to remain active before asserting  $\overline{\text{FLT}}$  pin.**Note 4:** The mask timer occurs each time PWM goes from low to high. Open LED condition cannot be detected during the mask time period.**Note 5:** Device is designed for use in applications with continuous 18V operation, and meets Electrical Characteristics table up to the maximum supply voltage.

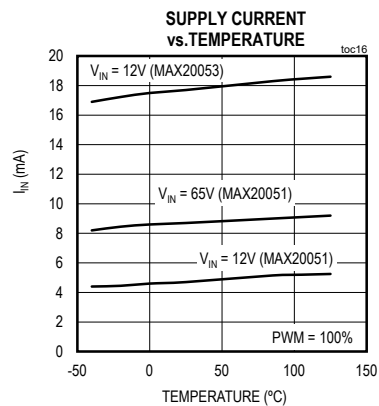
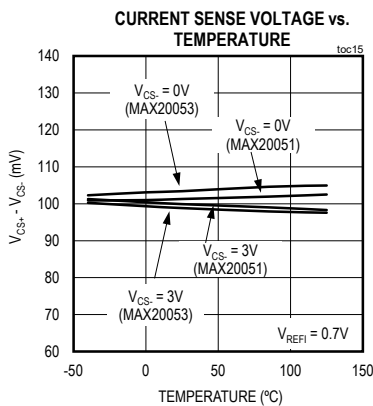
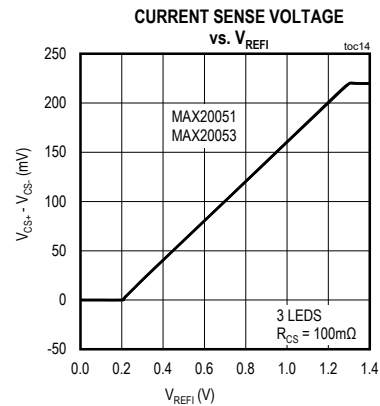
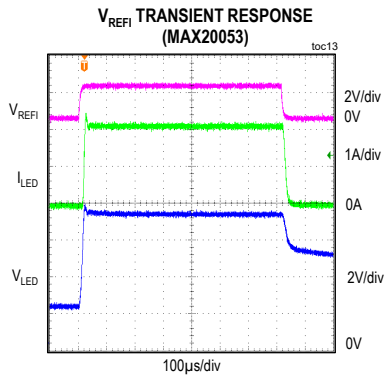
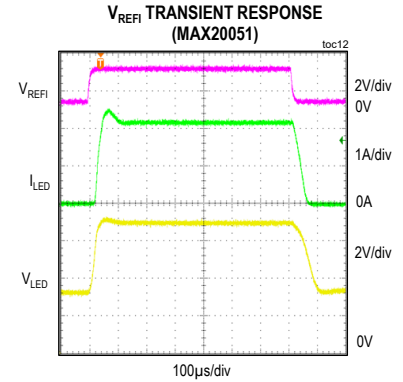
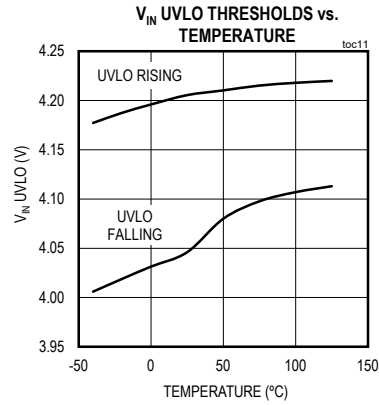
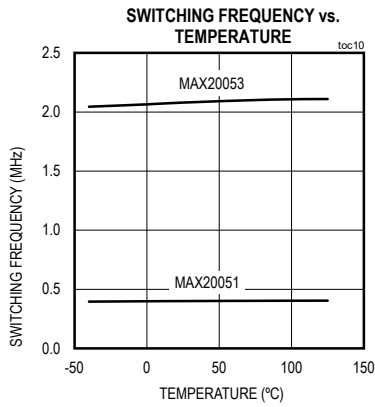
## Typical Operating Characteristics

( $V_{IN} = 12V$ ,  $V_{REF1} = 1.2V$ ,  $V_{PWM} = V_{CC}$ ,  $T_A = +25^\circ C$ , unless otherwise noted.)

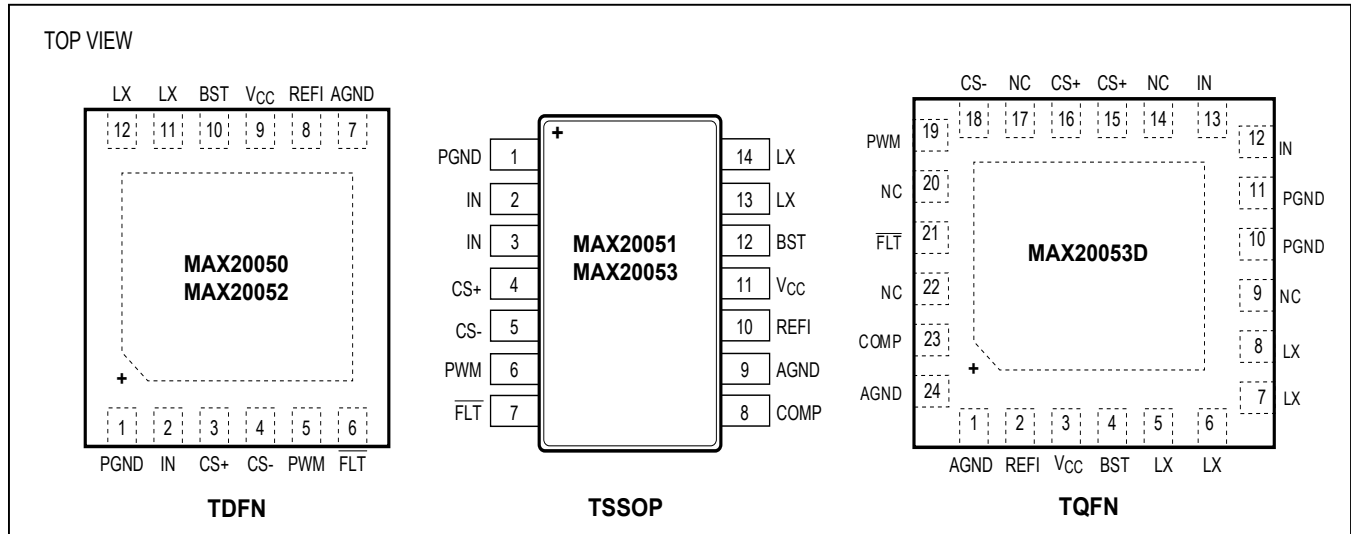


Typical Operating Characteristics (continued)

( $V_{IN} = 12V$ ,  $V_{REF1} = 1.2V$ ,  $V_{PWM} = V_{CC}$ ,  $T_A = +25^\circ C$ , unless otherwise noted.)



## Pin Configurations



## Pin Descriptions

| TDFN                 | TSSOP                | NAME            | FUNCTION                                                                                                                                                                                                                                                                                                                     |
|----------------------|----------------------|-----------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| MAX20050<br>MAX20052 | MAX20051<br>MAX20053 |                 |                                                                                                                                                                                                                                                                                                                              |
| 1                    | 1                    | PGND            | Power Ground                                                                                                                                                                                                                                                                                                                 |
| 2                    | 2, 3                 | IN              | Power-Supply Input. Bypass to PGND with a minimum of 1μF ceramic capacitor.                                                                                                                                                                                                                                                  |
| 3                    | 4                    | CS+             | Current-Sense Positive Pin. This is the positive input of the high-side average current-mode control amplifier. See the <i>Programming the LED Current</i> section for information on setting the resistor value. The output inductor and current-sense resistor are connected at this node.                                 |
| 4                    | 5                    | CS-             | Current-Sense Negative Pin. This is the negative input of the high-side average current-mode control amplifier. See the <i>Programming the LED Current</i> section for information on setting the resistor value. This node goes to the anode of the LED string. One end of the current-sense resistor connects to this pin. |
| 5                    | 6                    | PWM             | Logic-Level Dimming Input. Drive PWM low to turn off the current regulator. PWM should be left floating for 100% duty cycle applications. For PWM dimming applications, see the <i>PWM Dimming Control</i> section for more details. If PWM is driven low for greater than 210ms, the device turns off.                      |
| 6                    | 7                    | FLT             | Open-Drain Fault Output. See the <i>Fault Pin Behavior</i> section for information on Fault.                                                                                                                                                                                                                                 |
| —                    | 8                    | COMP            | Compensation Output (MAX20051/MAX20053). Connect an external RC network for loop compensation. The MAX20050/MAX20052 are internally compensated.                                                                                                                                                                             |
| 7                    | 9                    | AGND            | Analog Ground                                                                                                                                                                                                                                                                                                                |
| 8                    | 10                   | REFI            | Analog Dimming-Control Input. Connect an analog voltage from 0 to 1.2V for analog dimming of LED current.                                                                                                                                                                                                                    |
| 9                    | 11                   | V <sub>CC</sub> | 5V Regulator Output. Connect a 1μF ceramic capacitor to AGND from this pin for stable operation.                                                                                                                                                                                                                             |
| 10                   | 12                   | BST             | High-Side Power Supply for Gate Drive. Connect a 0.1μF ceramic capacitor from BST to LX.                                                                                                                                                                                                                                     |
| 11, 12               | 13, 14               | LX              | Switching Node. Connect to one end of output inductor.                                                                                                                                                                                                                                                                       |
| —                    | —                    | EP              | Exposed Pad. Connect EP to a large-area ground plane for effective power dissipation. Connect EP to AGND. Do not use as the only ground connection.                                                                                                                                                                          |

## Pin Descriptions (continued)

| TQFN       | NAME                    | FUNCTION                                                                                                                                                                                                                                                                                                                              |
|------------|-------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| MAX20053D  |                         |                                                                                                                                                                                                                                                                                                                                       |
| 1, 24      | AGND                    | Analog Ground. Pins 1 and 24 should be shorted outside the IC.                                                                                                                                                                                                                                                                        |
| 2          | REFI                    | Analog Dimming-Control Input. Connect an analog voltage from 0 to 1.2V for analog dimming of LED current.                                                                                                                                                                                                                             |
| 3          | V <sub>CC</sub>         | 5V Regulator Output. Connect a 1μF ceramic capacitor to AGND from this pin for stable operation.                                                                                                                                                                                                                                      |
| 4          | BST                     | High-Side Power Supply for Gate Drive. Connect a 0.1μF ceramic capacitor from BST to LX.                                                                                                                                                                                                                                              |
| 5, 6, 7, 8 | LX                      | Switching Node. Connect to one end of output inductor.                                                                                                                                                                                                                                                                                |
| 9          | NC                      | No Connect                                                                                                                                                                                                                                                                                                                            |
| 10, 11     | PGND                    | Power Ground                                                                                                                                                                                                                                                                                                                          |
| 12, 13     | IN                      | Power-Supply Input. Bypass to PGND with a minimum of 1μF ceramic capacitor.                                                                                                                                                                                                                                                           |
| 14         | NC                      | No Connect                                                                                                                                                                                                                                                                                                                            |
| 15, 16     | CS+                     | Current-Sense Positive Pin. This is the positive input of the high-side average current-mode control amplifier. See the <a href="#">Programming the LED Current</a> section for information on setting the resistor value. The output inductor and current-sense resistor are connected at this node.                                 |
| 17         | NC                      | No Connect                                                                                                                                                                                                                                                                                                                            |
| 18         | CS-                     | Current-Sense Negative Pin. This is the negative input of the high-side average current-mode control amplifier. See the <a href="#">Programming the LED Current</a> section for information on setting the resistor value. This node goes to the anode of the LED string. One end of the current-sense resistor connects to this pin. |
| 19         | PWM                     | Logic-Level Dimming Input. Drive PWM low to turn off the current regulator. PWM should be left floating for 100% duty cycle applications. For PWM dimming applications, see the <a href="#">PWM Dimming Control (PWM)</a> section for more details. If PWM is driven low for greater than 210ms, the device turns off.                |
| 20         | NC                      | No Connect                                                                                                                                                                                                                                                                                                                            |
| 21         | $\overline{\text{FLT}}$ | Open-Drain Fault Output. Refer to the <a href="#">Fault Pin Behavior</a> section for information on Fault.                                                                                                                                                                                                                            |
| 22         | NC                      | No Connect                                                                                                                                                                                                                                                                                                                            |
| 23         | COMP                    | Compensation Output. Connect an external RC network for loop compensation.                                                                                                                                                                                                                                                            |
| —          | EP                      | Exposed Pad. Connect EP to a large-area ground plane for effective power dissipation. Connect EP to AGND. Do not use as the only ground connection.                                                                                                                                                                                   |

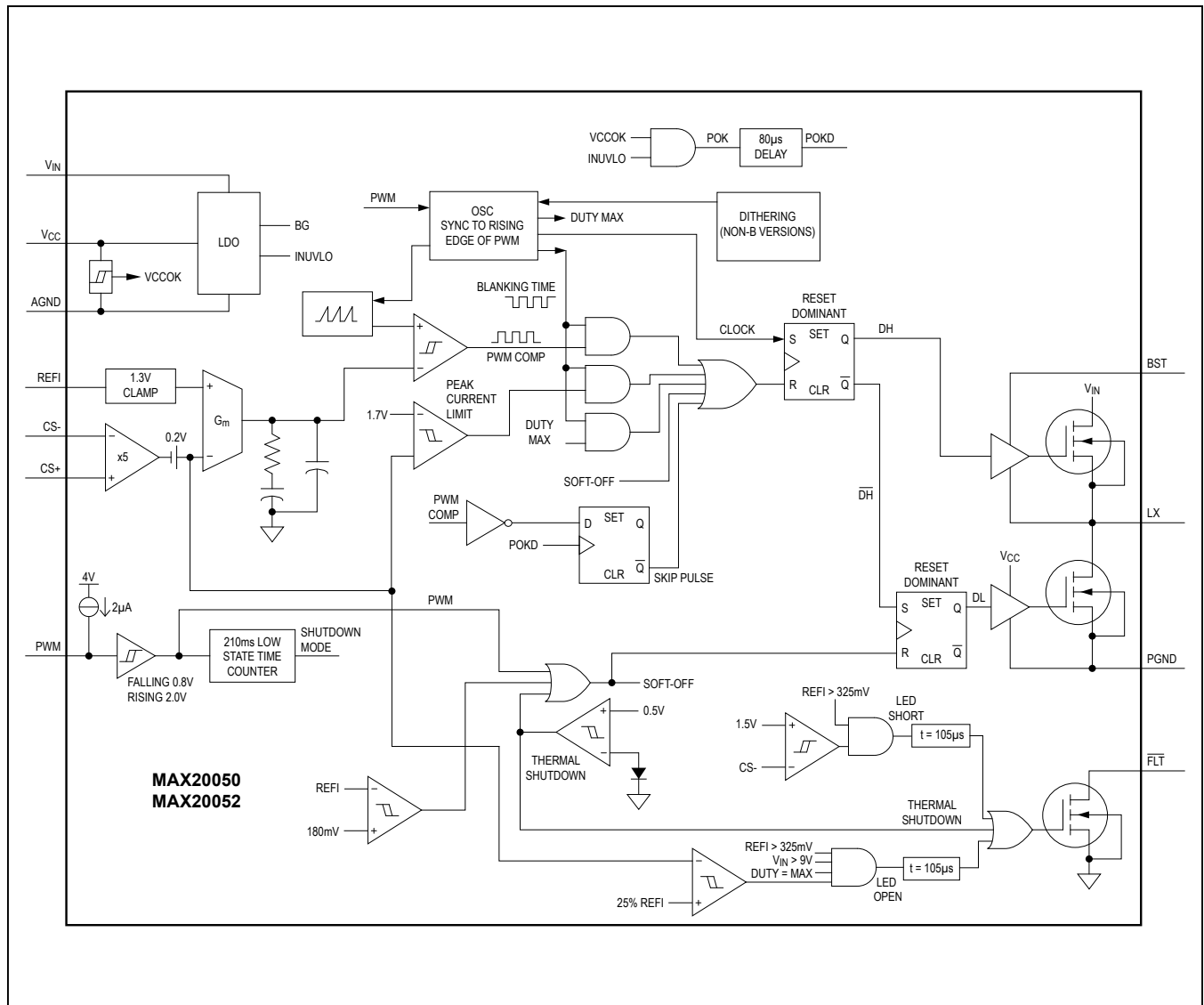


Figure 1. Block Diagram of the MAX20050/MAX20052

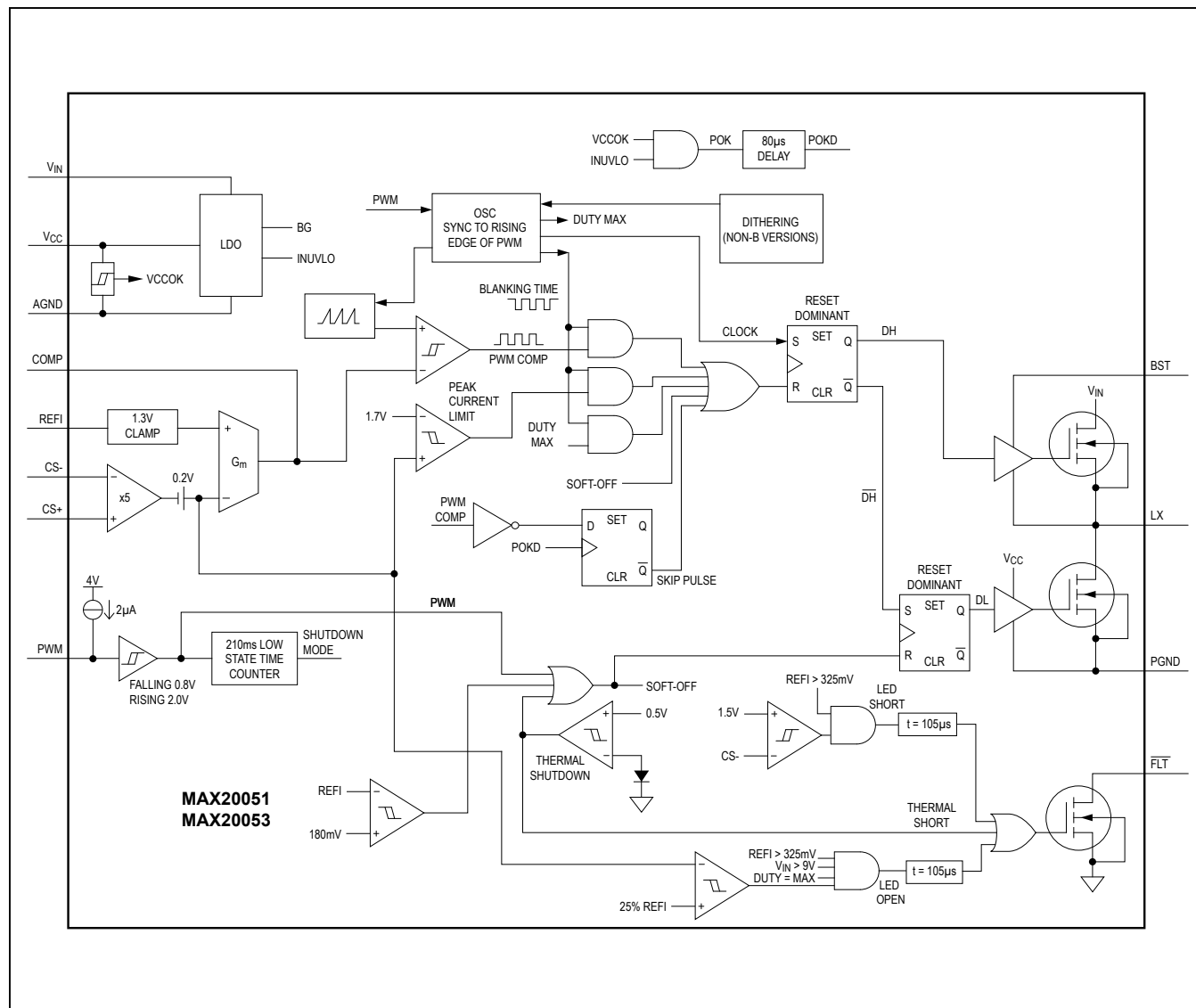


Figure 2. Block Diagram of the MAX20051/MAX20053

## Detailed Description

The MAX20050–MAX20053 are HB LED drivers for automotive exterior lighting applications. Consisting of a fully synchronous step-down converter with integrated MOSFETs, the devices are capable of driving a series string of LEDs at up to 2A, with a minimum number of external components. The MAX20050/MAX20052 utilize internal loop compensation to minimize component count, while the MAX20051/MAX20053 use external compensation for full flexibility.

The wide 4.5V to 65V input supply range supports extreme automotive cold-crank and load-dump conditions. A low- and high-switching frequency option (400kHz or 2.1MHz) provides the designer with the flexibility to optimize for solution size or efficiency, while avoiding interference within the AM band. Spread spectrum provides further options for the designer to reduce EMI at the system level. The MAX20050/MAX20051 have an internal switching frequency of 400kHz, while the MAX20052/MAX20053 have an internal switching frequency of 2.1MHz.

High-side current regulation means only a single connection to the LED string is required; grounding of the string can be done locally. In addition to PWM dimming, the ICs provide analog dimming using the REF1 pin. Full-scale current regulation accuracy is  $\pm 2.5\%$ , while the accuracy is  $\pm 8\%$  at 10% of full scale, over the full temperature range of  $-40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$ . A 5V, 10mA LDO output is available for biasing other circuits.

Fault-protection mechanisms include output overload, short-circuit, and device overtemperature protections.

## Functional Operation of MAX20050–MAX20053

The MAX20050–MAX20051 are monolithic, constant frequency average current mode step-down DC-DC LED drivers. A fixed frequency internal oscillator sets the switching frequency of the devices. For the MAX20050/MAX20051, the switching frequency is set at 400kHz, and for the MAX20052/MAX20053, the switching frequency is set at 2.1MHz. Spread spectrum is added to the internal oscillator to improve the EMI performance of the LED driver at higher frequencies. The oscillator turns on the internal top power switch at the beginning of each clock cycle. Current in the inductor then increases until the internal PWM comparator trips and turns off the top power switch. The duty cycle at which the top switch turns off is controlled by an internal PWM comparator that has the output of an error amplifier going to the negative input of the comparator and a saw tooth ramp going to the positive input of the comparator. The error amplifier

is a transconductance amplifier that compares the analog control voltage REF1 with an amplified current sense signal. The output of the error amplifier is then fed to a PWM comparator. The other input of the PWM comparator is a saw tooth ramp with a peak to peak voltage of 2.25V. The REF1 voltage programs the LED current. When the top power switch turns off, the synchronous power switch at the bottom turns on until the next clock cycle begins. The current sense signal is derived by a current sense resistor in series with the output inductor. This current sense signal is amplified by a factor of 5 and is then fed to the input of the error amplifier. This amplified signal is also fed to a comparator input which compares the amplified current sense signal with a 300mV reference. If the amplified current sense signal exceeds 300mV, then the top switch is immediately turned off independent of the PWM comparator and the bottom synchronous switch is turned on until the start of the next oscillator cycle. In the MAX20050/MAX20052, the output of the error amplifier is not available and the loop compensation is fixed inside the device. In the MAX20051/MAX20053, the output of the error amplifier appears on a pin and the loop can be compensated externally.

The device also includes a PWM dimming input that is used for PWM dimming of the LED current. When this signal is low both, the top and bottom switches are turned off and when the PWM signal goes high the inductor current is controlled by the device. The rising edge of the PWM signal also restarts the internal oscillator allowing the top switch to be turned on at the same instant as the rising edge of the PWM signal. This provides consistent dimming performance at low dimming duty cycles. The PWM signal can also be used as an enable input where if the PWM signal stays low for a period exceeding 200ms the device goes into a shutdown mode. In shutdown mode, the quiescent current drawn by the device goes to 5 $\mu\text{A}$  at an input of 12V.

The devices also feature a fault flag that indicates open or shorts on the output. Thermal shutdown shuts down the devices to protect them from damage at high temperatures.

## Analog Dimming

The devices have an analog dimming-control input (REF1). The voltage at REF1 sets the LED current level when  $V_{\text{REF1}} \leq 1.2\text{V}$ . For  $V_{\text{REF1}} > 1.2\text{V}$ , REF1 is clamped to 220mV (typ). The maximum withstand voltage of this input is 5.5V. The LED current is guaranteed to be at zero when the REF1 voltage is at or below 0.18V. The LED current can be linearly adjusted from zero to full scale for the REF1 voltage in the range of 0.2V to 1.2V.

**High-Side Current Sense (CS+, CS-)**

A resistor is connected between the inductor and the anode of the LED string to program the maximum LED current. The full-scale signal is 200mV. The CS+ pin should be connected to the positive terminal of the current-sense resistor (inductor side) and the CS- pin should be connected to the negative terminal of the current-sense resistor (LED string anode side).

**PWM Dimming Control (PWM)**

A low signal on this pin turns off both the high- and low-side MOSFETs. The device goes into shutdown mode if there is no positive-going dimming pulse for 210ms. In shutdown mode, the input current is less than 5 $\mu$ A (typ) and the  $V_{CC}$  output goes to zero.

Float the PWM pin for 100% duty cycle applications. Do not pull the PWM pin to  $V_{CC}$  directly or through a resistor.

For PWM dimming applications, drive the PWM pin with the driver supply connected to an external supply independent of  $V_{CC}$ . See [Figure 3a](#).

The PWM pin can also be driven with an open-drain transistor. For pullup, the PWM pin needs to be pulled up through a resistor to an external supply independent of  $V_{CC}$ . See [Figure 3b](#). For the MAX2005XE version parts ONLY, the external supply shown in [Figure 3a](#) and [Figure 3b](#) can be

$V_{CC}$ . When using the “E” version parts with  $V_{CC}$  for the external supply, the PWM pin cannot be pulled low for >210ms (typ), as the part enters shutdown and  $V_{CC}$  goes to zero.

**5V Regulator ( $V_{CC}$ )**

A regulated 5V output is provided for biasing other circuitries up to 10mA load. Bypass  $V_{CC}$  to AGND with a minimum of 1 $\mu$ F ceramic capacitor as close as possible to the device.

**Input Voltage (IN)**

The input supply pin (IN) must be locally bypassed with a minimum of 1 $\mu$ F capacitance close to the pin. All the input current that is drawn by the LED driver goes through this pin. The positive terminal of the bypass capacitor must be placed as close as possible to this pin and the negative terminal of the bypass capacitor must be placed as close as possible to the PGND pin.

**Switching Node (LX)**

The source of the internal high-side switching MOSFET and the drain of the low-side synchronous switching MOSFET is connected to these pins. Connect these pins together externally and connect them to the inductor and the boost capacitor. The  $R_{DS(ON)}$  of both the high- and low-side switching MOSFETs is 0.3 $\Omega$  maximum at a junction temperature of +125°C.

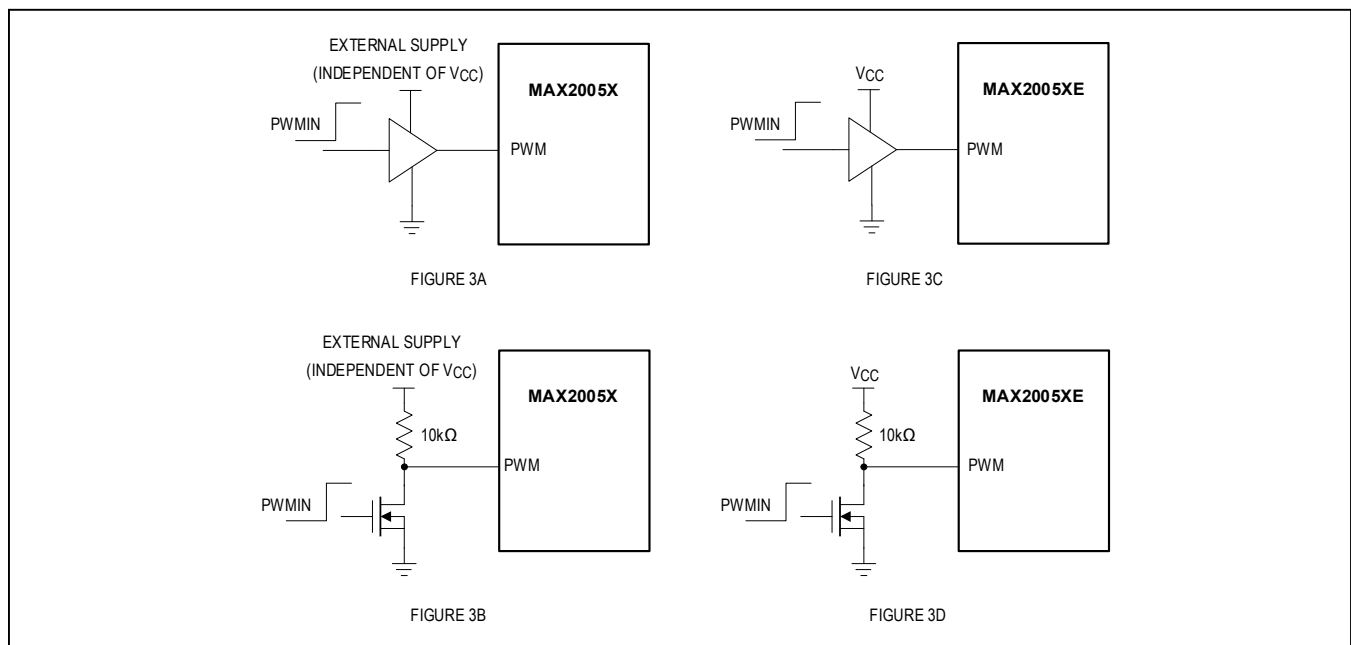


Figure 3. PWM Dimming Control

**Boost Capacitor Node (BST)**

The BST pin is used to provide a drive voltage to the high-side switching MOSFET that is higher than the input voltage. An internal diode is connected from BST to  $V_{CC}$ . Connect a 0.1  $\mu\text{F}$  ceramic capacitor from this pin to the LX pins. Place the capacitor as close as possible to this pin.

**Power Ground (PGND)**

The source of the internal low-side power MOSFET is connected to this pin. Place the negative terminal of the input bypass capacitor as close as possible to the PGND pin.

**Analog Ground (AGND)**

This is the analog ground pin for all the control circuitry of the LED driver. Connect the PGND and the AGND together at the negative terminal of the input bypass capacitor.

**Compensation (COMP)  
(MAX20051/MAX20053)**

The COMP pin is present in the MAX20051/MAX20053. Connect the external compensation network to this pin for stable loop compensation.

**Fault Pin Behavior**

The  $\overline{\text{FLT}}$  pin is an open-drain output. See the [LED Open](#) and [LED Short](#) sections.

**LED Open**

The LED open is detected when the following conditions are true at the same time for a period longer than 105  $\mu\text{s}$ :

- Input voltage > 9V
- $\text{REFI} > 325\text{mV}$
- Current sense < 25% expected REFI value
- Max duty cycle

If an LED open is detected and the input voltage goes below 9V or REFI goes below 325mV, the  $\overline{\text{FLT}}$  flag remains asserted until the input voltage goes above 9V and REFI goes above 325mV. If PWM is high and a LED open occurs, the  $\overline{\text{FLT}}$  pin asserts after a deglitch period of 105  $\mu\text{s}$ . When the PWM goes low, the  $\overline{\text{FLT}}$  status is latched. LED open condition cannot be detected if PWM pulse width is shorter than the maximum mask timer period of 300  $\mu\text{s}$ .

The LED open condition cannot be detected if the PWM pulse width is shorter than the mask timer period. The mask timer counter uses an internal clock (15  $\mu\text{s}$  (typ) period) to perform the mask timing measurement. If the PWM dimming pulse is in the range of 140  $\mu\text{s}$  to 300  $\mu\text{s}$ , there is a

timing window of 1-clock cycle width (210  $\mu\text{s}$  to 225  $\mu\text{s}$ , typ), where the  $\overline{\text{FLT}}$  pin can toggle between high and low state from one PWM dimming pulse to another in case of an LED open fault. If the PWM pulse width is longer than the mask timer period and an LED open fault is detected, the  $\overline{\text{FLT}}$  flag goes low. Once the open LED fault condition disappears, the  $\overline{\text{FLT}}$  flag goes high.

**LED Short**

The LED short is detected when the following two conditions are true at the same time for a period longer than 105  $\mu\text{s}$ :

- $\text{REFI} > 325\text{mV}$
- Output voltage < 1.5V

After LED short is recovered, the fault flag is deasserted, irrelevant to the input voltage.

**Thermal Shutdown**

The  $\overline{\text{FLT}}$  pin goes low when thermal shutdown is activated.

**Exposed Pad**

The device package features an exposed thermal pad on its underside that should be used as a heat sink. This pad lowers the package's thermal resistance by providing a direct heat-conduction path from the die to the PCB. Connect the exposed pad and AGND together using a large pad or ground plane, or multiple vias to the AGND plane layer.

**Inductor Peak Current-Limit Comparator**

The peak current comparator provides a path for fast cycle-by-cycle current limit during extreme fault conditions. The average current-limit threshold, set by the REFI voltage, limits the output current during short circuit.

**Spread-Spectrum Modulation**

The devices include a unique spread-spectrum mode that reduces emission (EMI) at the switching frequency and its harmonics.

The spread spectrum uses a pseudorandom dithering technique, where the switching frequency is varied in the range of 400kHz  $\pm 3\%$  for the MAX20050/MAX20051 and 2.1MHz  $\pm 3\%$  for the MAX20052/MAX20053.

Instead of a large amount of spectral energy present at multiples of the switching frequency, the total energy at the fundamental and each harmonic is spread over a wider bandwidth, reducing the energy peak.

Spread-spectrum modulation is disabled in B versions of the device.

## Thermal Protection

The devices feature thermal protection. When the junction temperature exceeds +165°C, the LX pin starts operating at the minimum pulse width to reduce the power dissipation in the internal power MOSFETs. The part returns to regulation mode once the junction temperature goes below +155°C. This results in a cycled output during continuous thermal-overload conditions.

## High-Side Current-Sense Amplifier

The devices feature a high-bandwidth, high-side current-sense amplifier that is used to sense the inductor current. The gain of this current-sense amplifier is 5. The differential voltage between CS+ and CS- is fed to the internal high-side current-sense amplifier. This amplified signal is then transferred to the low side and is then connected to the negative input of an internal transconductance amplifier. The 3dB bandwidth of the high-side current-sense amplifier is 1.5MHz.

## Internal Transconductance Amplifier

The devices have a built-in transconductance amplifier used to amplify the error signal inside the feedback loop. The output of the high-side current-sense amplifier, plus an offset voltage of 0.2V, is fed to the negative input of this internal transconductance amplifier. The positive input is the voltage on the REFI pin. In the case of the MAX20050/MAX20052, the loop of this amplifier is inter-

nally compensated and is not available as an output pin. In the case of the MAX20051/MAX20053, the output of this amplifier is available on the COMP pin and can be compensated with an external compensation network. The transconductance of this amplifier is 600μS.

## Applications Information

### Programming the LED Current

Normal sensing of the LED current should be done on the high side where the LED current-sense resistor is connected to the inductor. The other side of the LED current-sense resistor goes to the anode of the external LED string. The LED current is programmed using R<sub>CS</sub> (see Figure 4). When REFI is set to a voltage >1.3V, the internal reference regulates the voltage across R<sub>CS</sub> to 220mV. The current is given by:

$$I_{LED} = \frac{0.220}{R_{CS}}$$

The LED current can also be programmed using the voltage on REFI when V<sub>REFI</sub> ≤ 1.2V (analog dimming). The current is given by:

$$I_{LED} = \frac{(V_{REFI} - 0.2)}{(5 \times R_{CS})}$$

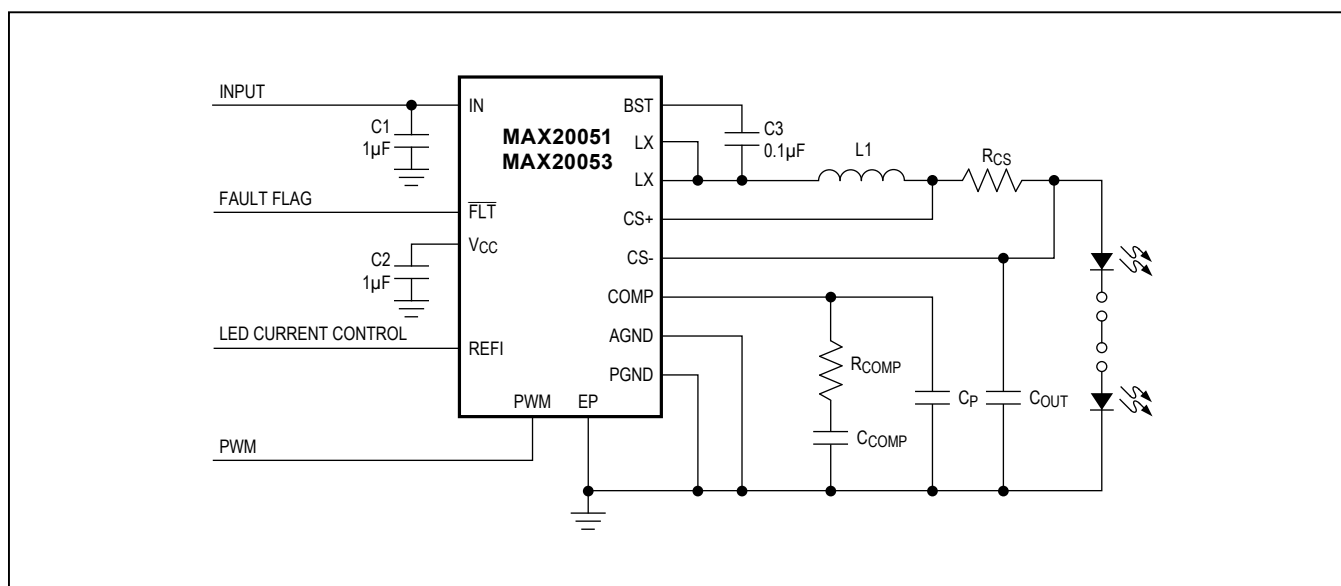


Figure 4. Typical Application Circuit Using the MAX20051

### Inductor Selection

The peak inductor current, selected switching frequency, and the allowable inductor current ripple determine the value and size of the output inductor. The MAX20050/MAX20051 have an internal switching frequency of 400kHz, whereas the MAX20052/MAX20053 have a switching frequency of 2.1MHz. Selecting a higher switching frequency reduces the inductance requirements, but at the cost of efficiency. The charge/discharge cycle of the gate capacitance of the internal switching MOSFET's gate and drain capacitance create switching losses, which worsen at higher input voltages since the switching losses are proportional to the square of the input voltage. Choose inductors from the standard high-current, surface-mount inductor series available from various manufacturers. High inductor ripple current causes large peak-to-peak flux excursion, increasing the core losses at higher frequencies.

For the typical operating circuit of [Figure 5](#) ( $V_{IN} = 12V$ ), the inductor value has to be in the range of  $22\mu H$  to  $33\mu H$  for the MAX20050 and in the range of  $10\mu H$  to  $68\mu H$  for the MAX20052. For the typical application circuit of [Figure 6](#) ( $V_{IN} = 24V$ ), the inductor value has to be in the range of  $33\mu H$  to  $82\mu H$  for the MAX20050. For the typical application circuit of [Figure 7](#) ( $V_{IN} = 40V$  to  $60V$ ), the inductor value has to be in the range of  $47\mu H$  to  $150\mu H$  for the MAX20050. For the MAX20051/MAX20053, the inductor value can be optimized further and can be higher or lower than the values suggested for the MAX20050/MAX20052. The MAX20051/MAX20053 have an external

compensation pin for loop stability and this gives more flexibility for output inductor values.

### Input Capacitor

The discontinuous input-current waveform of the buck converter causes large ripple currents in the input capacitor. The switching frequency, peak inductor current, and the allowable peak-to-peak voltage ripple reflected back to the source dictate the capacitance requirement. The input ripple is comprised of  $\Delta V_Q$  (caused by the capacitor discharge) and  $\Delta V_{ESR}$  (caused by the ESR of the capacitor). Use low-ESR ceramic capacitors with high ripple-current capability at the input. A  $1\mu F$  ceramic capacitor is recommended for most applications.

### Output Capacitor

The function of the output capacitor is to reduce the output ripple to acceptable levels. The ESR, ESL, and the bulk capacitance of the output capacitor contribute to the output ripple. In most applications, using low-ESR ceramic capacitors can dramatically reduce the output ESR and ESL effects. To reduce the ESL effects, connect multiple ceramic capacitors in parallel to achieve the required bulk capacitance.

The output capacitance  $C_{OUT}$  is calculated using the following equation:

$$C_{OUT} = \frac{((V_{IN\_MIN} - V_{LED}) \times V_{LED})}{(\Delta V_R \times 2 \times L \times V_{IN\_MAX} \times f_{SW}^2)}$$

where  $\Delta V_R$  is the maximum allowable voltage ripple.

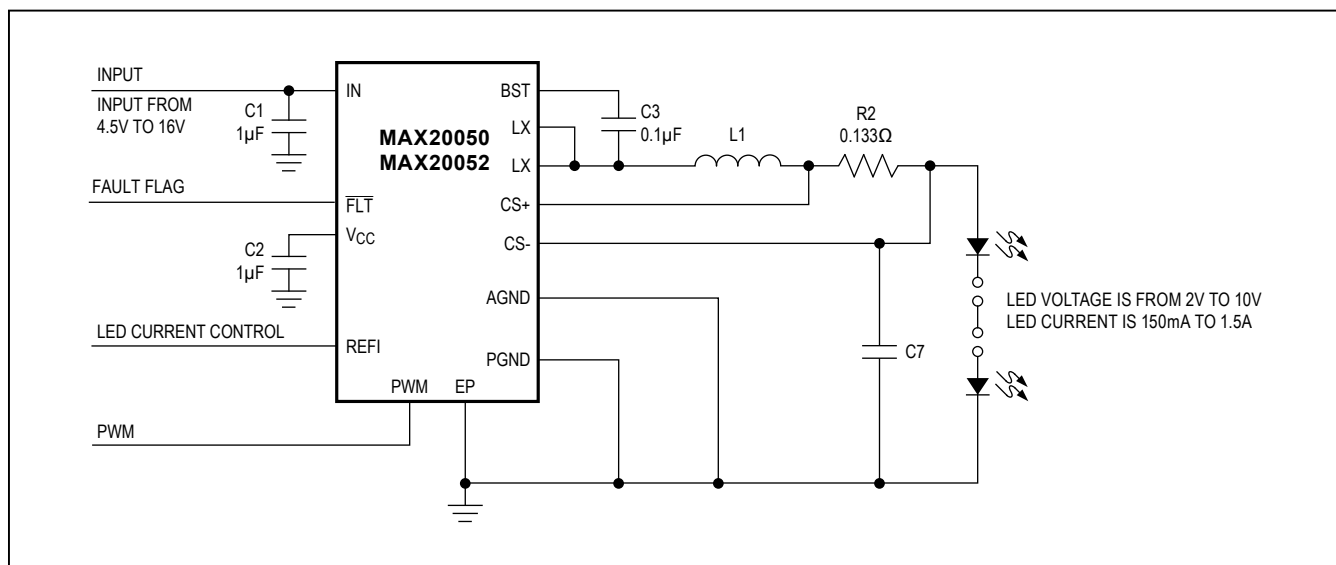


Figure 5. Typical Input Voltage (12V)

The output capacitance for MAX20050 in [Figure 5](#) has to be in the range of  $0.22\mu\text{F}$  to  $4.7\mu\text{F}$  for a stable operation. The output capacitance for MAX20052 has to be in the range of  $0.1\mu\text{F}$  to  $4.7\mu\text{F}$ . For the application circuit of [Figure 6](#), the output capacitance has to be in the range

of  $0.47\mu\text{F}$  to  $4.7\mu\text{F}$  for the MAX20050. For the application circuit of [Figure 7](#), the output capacitance has to be in the range of  $0.1\mu\text{F}$  to  $2.2\mu\text{F}$  for the MAX20050.

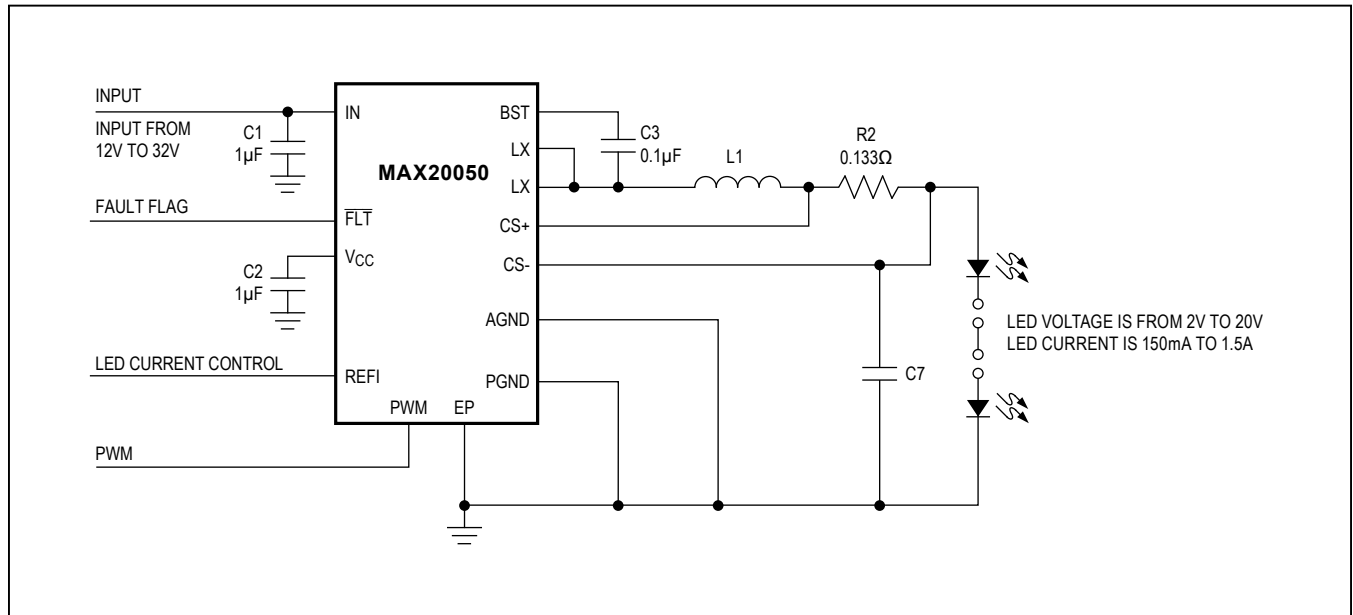


Figure 6. Typical Input Voltage (24V)

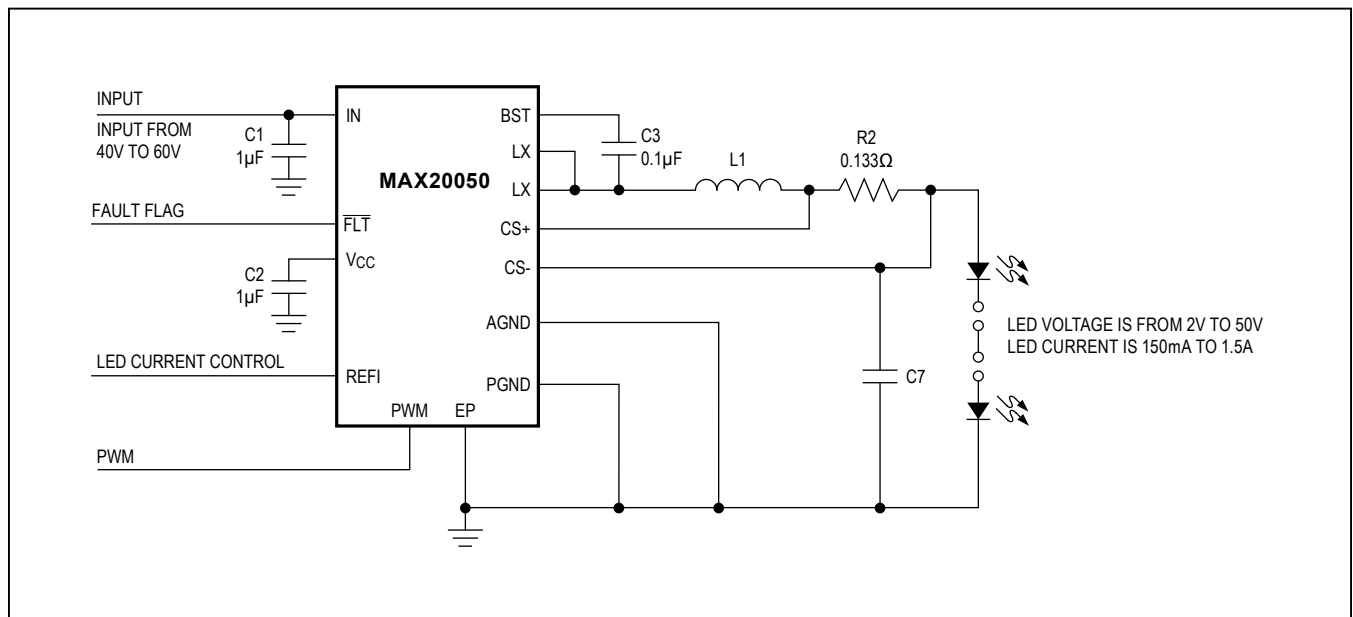


Figure 7. Typical Input Voltage (50V)

Table 1. Suggested L–C Network for Internally Compensated Parts

| L AND C COMPONENT VALUES (MAX20050, f <sub>SW</sub> = 400kHz) |  |                                       |      |     |    |
|---------------------------------------------------------------|--|---------------------------------------|------|-----|----|
| Output Capacitor Range (C7)                                   |  | V <sub>IN</sub> = 12V (typ), Figure 4 | 0.22 | 4.7 | μF |
|                                                               |  | V <sub>IN</sub> = 24V (typ), Figure 5 | 0.47 | 4.7 |    |
|                                                               |  | V <sub>IN</sub> = 55V (typ), Figure 6 | 0.1  | 2.2 |    |
| Inductor Range (L1)                                           |  | V <sub>IN</sub> = 12V (typ), Figure 4 | 22   | 33  | μH |
|                                                               |  | V <sub>IN</sub> = 24V (typ), Figure 5 | 33   | 82  |    |
|                                                               |  | V <sub>IN</sub> = 55V (typ), Figure 6 | 47   | 150 |    |
| L AND C COMPONENT VALUES (MAX20052, f <sub>SW</sub> = 2.1MHz) |  |                                       |      |     |    |
| Output Capacitor Range (C7)                                   |  | V <sub>IN</sub> = 12V (typ), Figure 4 | 0.1  | 4.7 | μF |
| Inductor Range (L1)                                           |  | V <sub>IN</sub> = 12V (typ), Figure 4 | 3.3  | 10  | μH |

### Compensation

The MAX20050/MAX20052 have internal loop compensation and there is no user-available adjustability of the loop compensation components. In the case of the MAX20051/MAX20053, an external COMP pin is present and an external compensation network is required for stable operation. See [Figure 4](#) for the typical application circuit using the MAX20051.

The compensator should be designed as follows. The high-side current sense amplifier introduces a high-frequency pole to around 420kHz. This is close to the switching frequency. The current loop gain is:

$$T_i(s) = \frac{F_m V_{IN}}{R} \times \frac{(1 + sRC_{OUT})}{\left(1 + s\frac{L}{R} + s^2 LC_{OUT}\right)} \times \frac{G_m (sC_{COMP} R_{COMP} + 1) 5R_{CS}}{sCOMP \left(1 + \frac{s}{w_p}\right)}$$

where  $G_m$  is the transconductance of the error amplifier inside the MAX20051/MAX20053,  $R_{CS}$  is the current sense resistor,  $R$  is the total dynamic resistance of the LED string,  $L$  is the inductance,  $R_{COMP}$  is the compensation resistor,  $C_{OUT}$  is the output capacitance,  $w_p$  is the pole from the high side current sense amplifier at  $2\pi f_p$  and  $F_m$  is the modulator gain that is given by:

$$F_m = \frac{1}{(s_e + s_n)T_s}$$

where  $T_s$  is  $1/f_s$  where  $f_s$  is the switching frequency,  $s_e$  is the  $dv/dt$  of the ramp in the PWM comparator which is

$2.25f_s$  and  $s_n$  is the  $dv/dt$  of the voltage from the output of the  $G_m$  amplifier.

In the MAX20051, the compensation zero formed by  $R_{COMP}C_{COMP}$  should be set at 20kHz and for the MAX20053 at 100kHz. Initially, the value of the capacitor  $C_{COMP}$  can be calculated by the formula:

$$\frac{G_m}{C_{COMP}} = \frac{Lf_s w_z}{\left(0.5 + \frac{1}{\pi}\right) F_m V_{IN} R_{CS}}$$

where  $w_z$  is the zero at  $R_{COMP}C_{COMP}$  and  $f_s$  is the switching frequency. Initially,  $F_m$  is assumed as 0.555 and the initial values of  $C_{COMP}$  is calculated and then  $R_{COMP}$  is calculated based on the zero location at 20kHz for the MAX20051 and 100kHz for the MAX20053. The values of  $R_{COMP}$ ,  $C_{COMP}$ , and  $C_P$  may need to be optimized further when testing, so as to get the optimum loop response.

### LED Current Derating Using REFI

The MAX20050–MAX20053 are designed specifically for driving high current LEDs. High current LEDs require derating the maximum current based on operating temperature to prevent damage of the LEDs. Some LEDs come with an accompanying thermistor in the same package. The thermistor may be an NTC. Under normal operating conditions the voltage on the REFI pin is above the clamp voltage of the MAX20050–MAX20053. See [Figure 8](#). As the temperature of the LEDs increase, the resistance  $R1$  decreases until the voltage on the REFI pin reaches 1.3V. The resistors  $R2$  and  $R1$  should be selected so that the voltage on REFI is 1.3V at the desired temperature  $T1$ . It may also be necessary that at a certain temperature  $T2$ , the current in the LEDs are close to zero.

At this temperature, the voltage on REFI pin is:

$$1.3 = \frac{V_{CC} \times R1(T1)}{(R1(T1) + R2)}$$

where  $V_{CC}$  is 5V and  $R1(T1)$  is the resistance of the resistor from REFI to ground at temperature  $T1$  and  $R2$  is the resistance from  $V_{CC}$  to REFI.

$$0.2 = \frac{V_{CC} \times R1(T2)}{(R1(T2) + R2)}$$

where  $R1(T2)$  is the resistance of the resistor of the resistor from REFI to ground at temperature  $T2$ . In some cases, the NTC in the LED can be used as is and in others, an additional resistor in series or in parallel or some other combination may need to be added to provide the desired resistance.

### High Peak-Current, Low Duty-Cycle Applications

The MAX20050–MAX20053 family of parts can be used for applications that require peak currents up to 5A with low duty cycle. The RMS current should not exceed 1.5A. A 3A Schottky diode must be added between LX and PGND pins when used in these applications. See [Figure 9](#).

### Low Dimming-Frequency Applications

For applications with low PWM dimming frequencies, it may be undesirable for the IC to go into shutdown mode between every PWM pulse. To prevent the IC from entering shutdown mode, a very narrow PWM pulse, typically 20ns to 100ns, can be sent by the microcontroller once every 100ms. This pulse will be short enough that it does not turn on the LEDs, but long enough that it keeps the IC awake.

### PCB Layout

For proper operation and minimum EMI, PCB layout should follow the guidelines below (also see [Figure 10](#)):

- 1) Large switched currents flow in the IN and PGND pins and the input capacitor C1 of [Figure 4](#). The loop formed by the input capacitor should be as small as possible by placing this capacitor as close as possible to the IN and PGND pins. The input capacitor, device, output inductor, and output capacitor should be placed on the same side of the PCB and the connections should be made on the same layer.
- 2) Place an unbroken ground plane on the layer closest to the surface layer with the inductor, device, and the input and output capacitors.
- 3) The surface area of the LX and BST nodes should be as small as possible to minimize emissions.
- 4) The exposed pad on the bottom of the package must be soldered to ground so that the pad is connected to ground electrically and also acts as a heat sink thermally. To keep thermal resistance low, extend the ground plane as much as possible, and add thermal vias under and near the device to additional ground planes within the circuit board.
- 5) Run the current-sense lines (CS+ and CS-) very close to each other to minimize the loop area. Do not cross these critical signal lines with power circuitry. Sense the current right at the pads of the current-sense resistors. The current-sense signal has a full-scale amplitude of 200mV. To prevent contamination of this signal from high dv/dt and high di/dt components and traces, use a ground plane layer to separate the power traces from this signal trace.
- 6) Use separate ground planes on different layers of the PCB for AGND and PGND. Connect both of these planes together at a single point close to the input bypass capacitor.
- 7) Use 2oz or thicker copper to keep trace inductances and resistances to a minimum. Thicker copper conducts heat more effectively, thereby reducing thermal impedance. Thin copper PCBs compromise efficiency in applications involving high currents.
- 8) Place capacitor C3 as close as possible to the BST and LX pins.

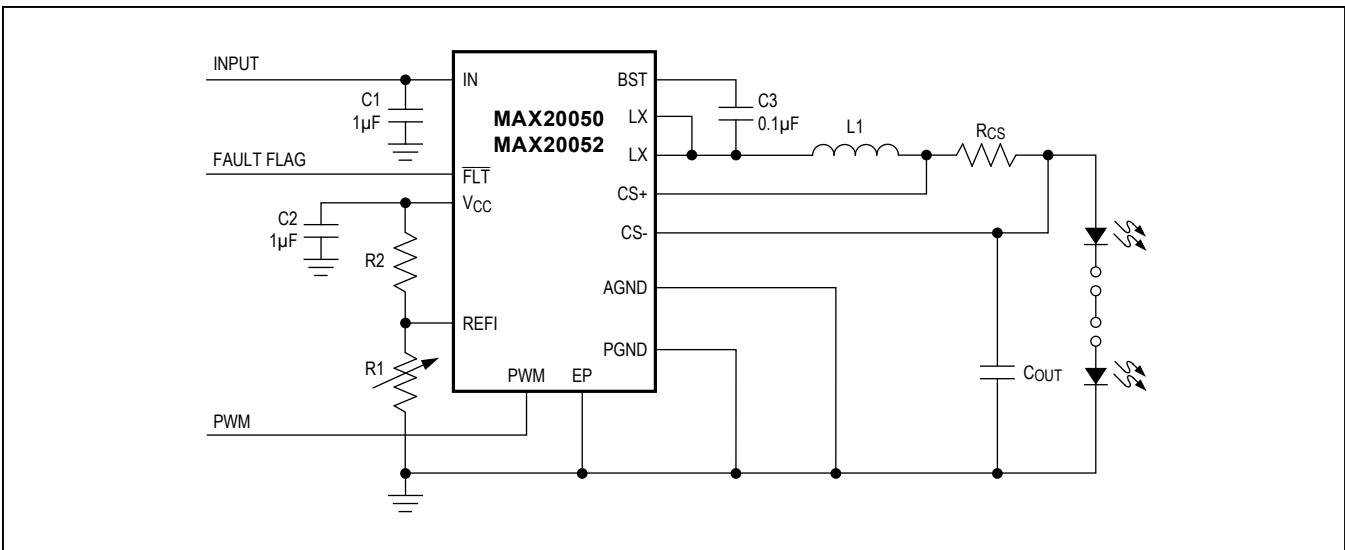


Figure 8. Application Circuit for LED Current Derating with Temperature

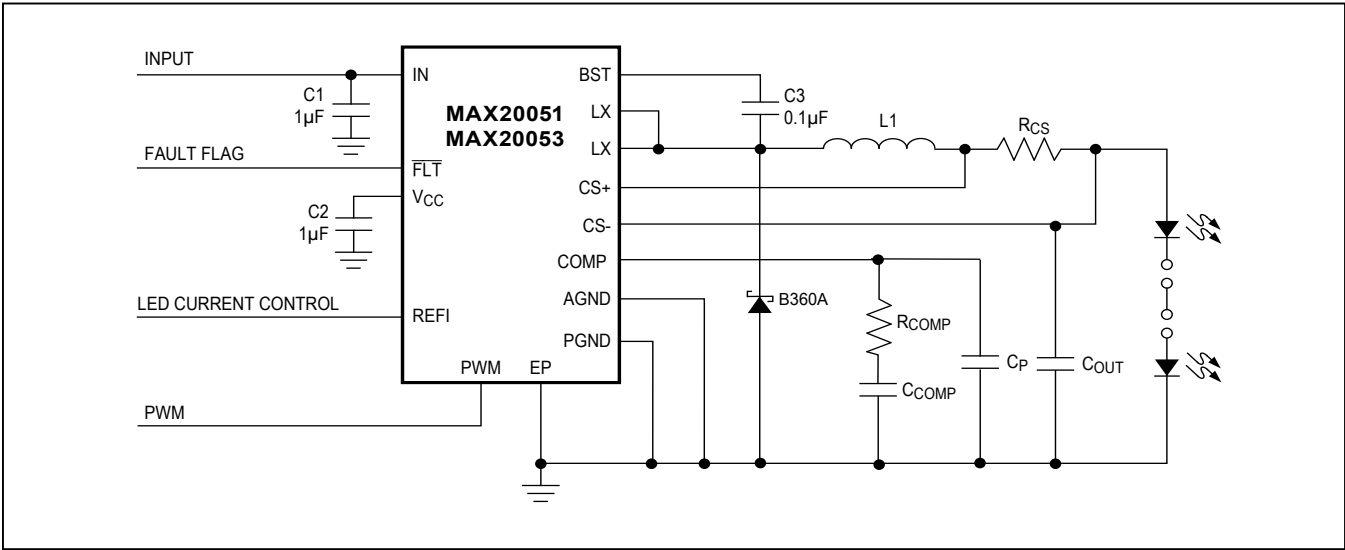


Figure 9. High-Current Application with MAX20051/MAX20053

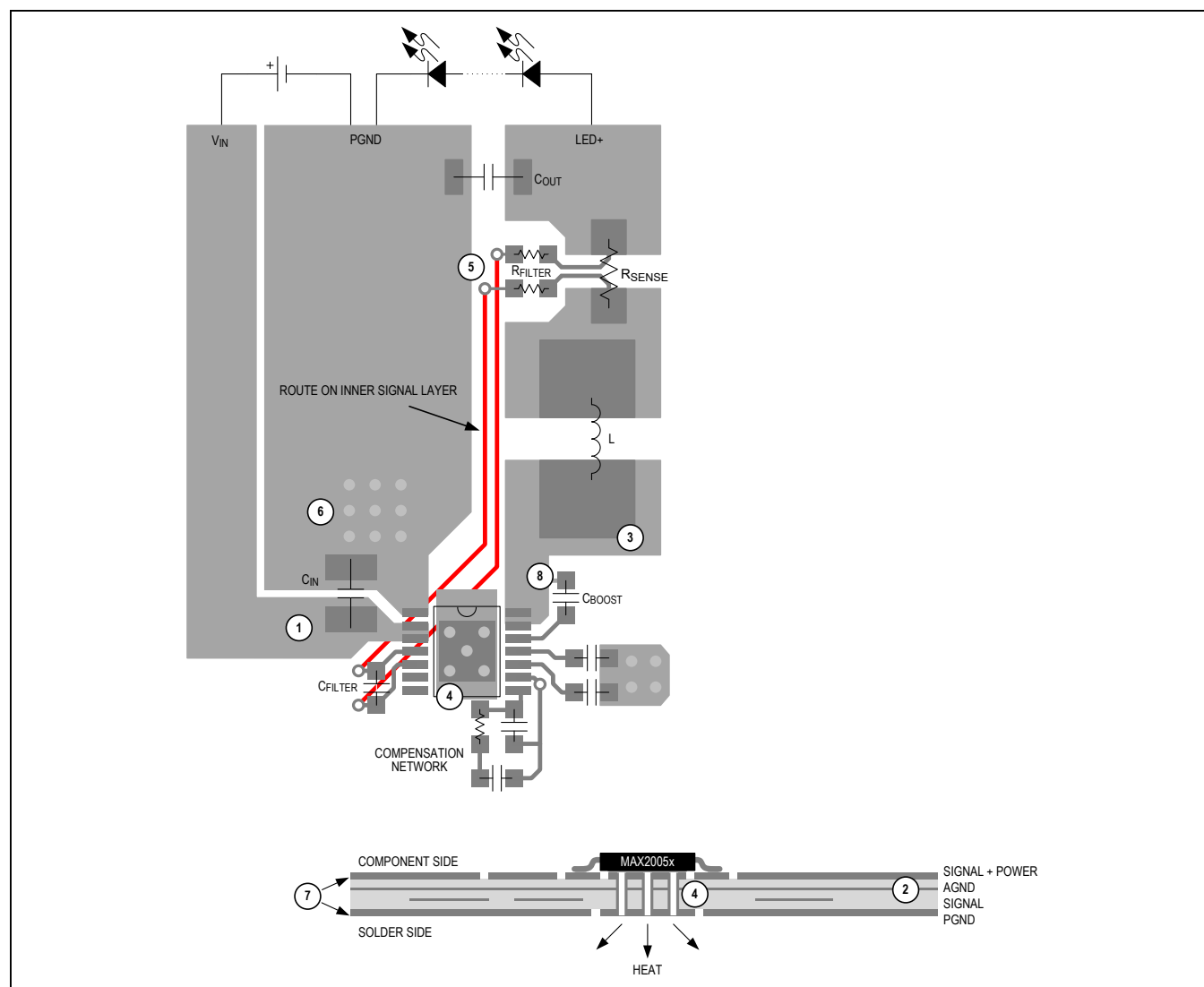


Figure 10. Section from MAX20051 EV Kit PCB Layout

## Ordering Information

| PART                    | INPUT SUPPLY RANGE | SWITCHING FREQUENCY | COMPENSATION | PIN-PACKAGE  |
|-------------------------|--------------------|---------------------|--------------|--------------|
| <b>MAX20050</b> EATC/V+ | 4.5V to 65V        | 400kHz              | Internal     | 12 TDFN-EP*  |
| MAX20050ATC/V+          | 4.5V to 65V        | 400kHz              | Internal     | 12 TDFN-EP*  |
| MAX20050ATC+            | 4.5V to 65V        | 400kHz              | Internal     | 12 TDFN-EP*  |
| MAX20050CATC/V+         | 4.5V to 36V        | 400kHz              | Internal     | 12 TDFN-EP*  |
| <b>MAX20051</b> EAUD/V+ | 4.5V to 65V        | 400kHz              | External     | 14 TSSOP-EP* |
| MAX20051AAUD/V+         | 4.5V to 65V        | 400kHz              | External     | 14 TSSOP-EP* |
| MAX20051AUD/V+          | 4.5V to 65V        | 400kHz              | External     | 14 TSSOP-EP* |
| MAX20051AAUD+           | 4.5V to 65V        | 400kHz              | External     | 14 TSSOP-EP* |
| MAX20051BAUD/V+         | 4.5V to 65V        | 400kHz (No SS)      | External     | 14 TSSOP-EP* |
| MAX20051CAUD/V+**       | 4.5V to 36V        | 400kHz              | External     | 14 TSSOP-EP* |
| <b>MAX20052</b> EATC/V+ | 4.5V to 65V        | 2.1MHz              | Internal     | 12 TDFN-EP*  |
| MAX20052ATC+            | 4.5V to 65V        | 2.1MHz              | Internal     | 12 TDFN-EP*  |
| MAX20052ATC/V+          | 4.5V to 65V        | 2.1MHz              | Internal     | 12 TDFN-EP*  |
| MAX20052BATC+           | 4.5V to 65V        | 2.1MHz (No SS)      | Internal     | 12 TDFN-EP*  |
| MAX20052BATC/V+**       | 4.5V to 65V        | 2.1MHz (No SS)      | Internal     | 12 TDFN-EP*  |
| MAX20052CATC/V+         | 4.5V to 36V        | 2.1MHz              | Internal     | 12 TDFN-EP*  |
| <b>MAX20053</b> EAUD/V+ | 4.5V to 65V        | 2.1MHz              | External     | 14 TSSOP-EP* |
| MAX20053AAUD+           | 4.5V to 65V        | 2.1MHz              | External     | 14 TSSOP-EP* |
| MAX20053AAUD/V+         | 4.5V to 65V        | 2.1MHz              | External     | 14 TSSOP-EP* |
| MAX20053AUD/V+          | 4.5V to 65V        | 2.1MHz              | External     | 14 TSSOP-EP* |
| MAX20053CAUD/V+         | 4.5V to 36V        | 2.1MHz              | External     | 14 TSSOP-EP* |
| MAX20053DATG/V+         | 4.5V to 36V        | 2.1MHz              | External     | 24 TQFN-EP*  |

/V denotes an automotive-qualified part.

+Denotes a lead(Pb)-free/RoHS-compliant package.

\*EP = Exposed pad.

\*\*Potential future product.

Note 1: For new designs, the “E” variant is recommended. Details of the E variant are described on page 13.

Note 2: There is no difference between the MAX20051AAUD/V+ and MAX20051AUD/V+, and there is no difference between the MAX20053AAUD/V+ and MAX20053AUD/V+. All devices now use copper bond wires.

## Package Information

For the latest package outline information and land patterns (footprints), go to [analog.com/en/resources/packaging-qual-ity-symbols-footprints/package-index.html](http://analog.com/en/resources/packaging-qual-ity-symbols-footprints/package-index.html). Note that a “+”, “#”, or “-” in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

| PACKAGE TYPE | PACKAGE CODE | OUTLINE NO.             | LAND PATTERN NO.        |
|--------------|--------------|-------------------------|-------------------------|
| 12 TDFN-EP   | TD1233+1C    | <a href="#">21-0664</a> | <a href="#">90-0397</a> |
| 14 TSSOP-EP  | U14E+4       | <a href="#">21-0108</a> | <a href="#">90-0463</a> |
| 14 TSSOP-EP  | U14E+4C      | <a href="#">21-0108</a> | <a href="#">90-0463</a> |
| 24 TQFN-EP   | T2444+4C     | <a href="#">21-0139</a> | <a href="#">90-0022</a> |

## Chip Information

PROCESS: BiCMOS

## Revision History

| REVISION NUMBER | REVISION DATE | DESCRIPTION                                                                                                                                                                                                                                                                                                                                   | PAGES CHANGED           |
|-----------------|---------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------|
| 0               | 3/14          | Initial release                                                                                                                                                                                                                                                                                                                               | —                       |
| 1               | 11/14         | Updated the LED Open-Fault Enable Threshold min/typ values in <i>Electrical Characteristics</i> table                                                                                                                                                                                                                                         | 4                       |
| 2               | 12/15         | Updated Current-Sense Input Offset, DMOS $R_{DS(on)}$ , and changed LED Open-Fault Enable Threshold, LED Open-Fault Enable Hysteresis in <i>Electrical Characteristics</i> table; changed LED Open and Logic $V_{IN}$ from 10.5V to 9V in Figures 1 and 2 and in the <i>LED Open</i> section; added new Figure 8 in <i>PCB Layout</i> section | 3, 4, 9, 10, 12, 13, 19 |
| 3               | 2/16          | Updated $V_{CC}$ Output Voltage in <i>Electrical Characteristics</i> table; removed future product designations in <i>Ordering Information</i> table                                                                                                                                                                                          | 2, 20                   |
| 4               | 5/16          | Updated Figure 8                                                                                                                                                                                                                                                                                                                              | 19                      |
| 5               | 6/16          | Added MAX20050ATC+ and MAX20051AUD+ to <i>Ordering Information</i> table                                                                                                                                                                                                                                                                      | 20                      |
| 6               | 6/16          | Added MAX20050ATC+T and MAX20051AUD+T to <i>Ordering Information</i> table                                                                                                                                                                                                                                                                    | 20                      |
| 7               | 6/16          | Changed land pattern number for TSSOP package in <i>Package Information</i> table                                                                                                                                                                                                                                                             | 20                      |
| 8               | 7/16          | Updated PWM pin in Figures 1 and 2                                                                                                                                                                                                                                                                                                            | 9, 10                   |
| 9               | 5/18          | Added MAX20051AAUD/V+ and MAX20053AAUD/V+ to <i>Ordering Information</i> table, as well as a new column for Bond Wire                                                                                                                                                                                                                         | 20                      |
| 10              | 10/18         | Added U14E+4C package code in <i>Package Information</i> table                                                                                                                                                                                                                                                                                | 20                      |
| 11              | 3/19          | Updated <i>Electrical Characteristics</i> table, block diagrams, and <i>Detailed Description</i> section for B version, added MAX20051BAUD/V+, MAX20052ATC+, and MAX20053AAUD+ to <i>Ordering Information</i> table                                                                                                                           | 3, 4, 9, 10, 13, 20     |
| 12              | 5/19          | Updated <i>Ordering Information</i> table to replace MAX20051AUD+ with MAX20051AAUD+                                                                                                                                                                                                                                                          | 20                      |
| 13              | 1/20          | Updated <i>General Description</i> , <i>Absolute Maximum Ratings</i> , <i>Electrical Characteristics</i> , <i>Applications Information</i> , and <i>Ordering Information</i> to add MAX2005xC parts                                                                                                                                           | 1, 2, 3, 14, 17, 18, 20 |
| 14              | 3/20          | Updated <i>Electrical Characteristics</i> , <i>Typical Operating Characteristics</i> , and <i>Applications Information</i>                                                                                                                                                                                                                    | 2, 4, 5, 17, 19         |
| 15              | 4/20          | Updated <i>General Description</i> , <i>Benefits and Features</i> , <i>Package Thermal Characteristics</i> , <i>Electrical Characteristics</i> , <i>Pin Configurations</i> , <i>Pin Descriptions</i> , <i>Typical Operating Characteristics</i> , and <i>Ordering Information</i>                                                             | 1, 2, 4, 7, 8, 21       |
| 16              | 8/20          | Updated <i>General Description</i> , <i>Benefits and Features</i> , <i>Package Thermal Characteristics</i> , <i>Electrical Characteristics</i> , and <i>Ordering Information</i>                                                                                                                                                              | 1–5, 22                 |
| 17              | 9/20          | Added MAX20052B information to DS, updated <i>Benefits and Features</i> , <i>Electrical Characteristics</i> , <i>PWM Dimming Control (PWM)</i> , and <i>Ordering Information</i>                                                                                                                                                              | 1, 3, 13, 22            |
| 18              | 11/20         | Updated <i>Applications</i> , <i>Ordering Information</i>                                                                                                                                                                                                                                                                                     | 1, 22                   |
| 19              | 7/21          | Updated <i>Ordering Information</i>                                                                                                                                                                                                                                                                                                           | 22                      |
| 20              | 7/21          | Updated <i>Electrical Characteristics</i> and <i>Ordering Information</i>                                                                                                                                                                                                                                                                     | 4, 22                   |
| 21              | 2/22          | Updated <i>Pin Descriptions</i> , Figures 1 and 2, and <i>Detailed Description</i> ; added Figure 3; updated <i>Ordering Information</i>                                                                                                                                                                                                      | 9–11, 13, 22            |
| 22              | 3/22          | Updated <i>Ordering Information</i>                                                                                                                                                                                                                                                                                                           | 22                      |
| 23              | 5/22          | Updated <i>Pin Descriptions</i> , Figures 1 and 2, <i>Detailed Description</i> , and <i>Ordering Information</i>                                                                                                                                                                                                                              | 8, 10, 11, 13, 22       |
| 24              | 12/24         | Updated Figure 3 and <i>Ordering Information</i>                                                                                                                                                                                                                                                                                              | 13, 22                  |



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